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(54) **ELECTROLUMINESCENT DISPLAY DEVICE
WITH ULTRAVIOLET PROTECTION FILM**

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(52) U.S. Cl. **313/506**; 313/504; 313/512

(58) Field of Search 313/506, 500,
313/504, 509, 512; 349/69, 42

(56) **References Cited**

U.S. PATENT DOCUMENTS

6,219,113 B1 * 4/2001 Takahara 349/42
2002/0140879 A1 * 10/2002 Fujieda 349/69
2003/0067266 A1 * 4/2003 Kim et al. 313/504

* cited by examiner

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(57) **ABSTRACT**

An electroluminescent display device includes an anode, a cathode and a light emitting layer disposed between the anode and the cathode. The display device also includes a substrate allowing light from the light emitting layer to pass through itself and an ultraviolet protection film disposed in an optical path of the light passing through the substrate. Retardation films and polarizers used in conventional electroluminescent display devices are replaced by the ultraviolet protection film with respect to reducing the effect of ultraviolet rays on the degradation of the display characteristics.

18 Claims, 6 Drawing Sheets

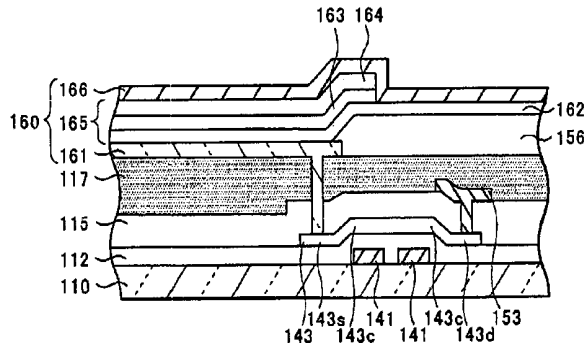
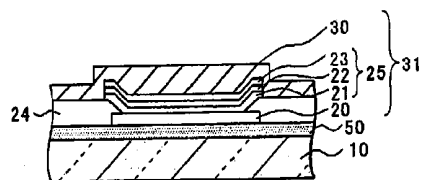


FIG.1A

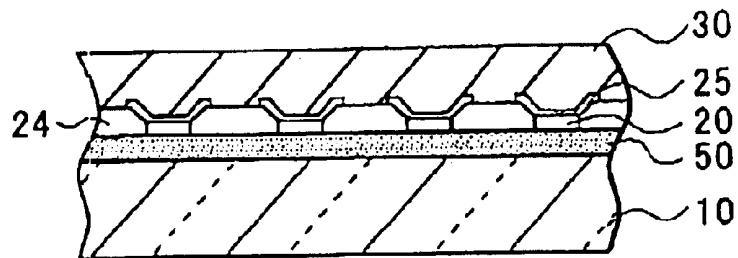


FIG.1B

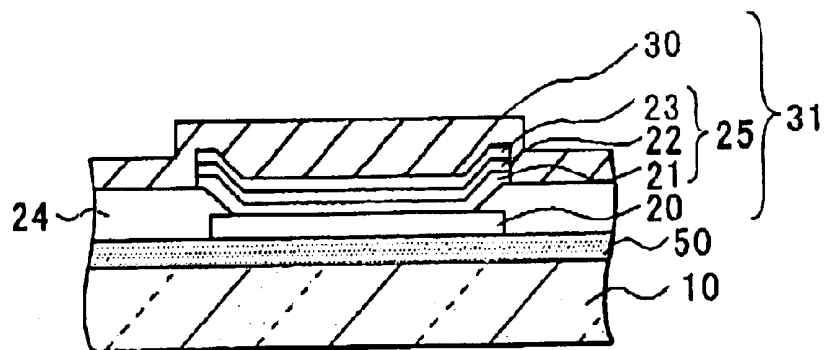


FIG.1C

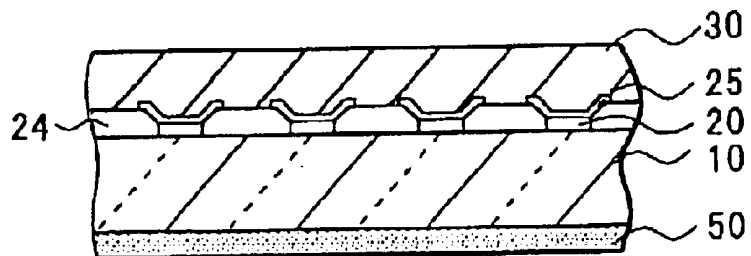


FIG. 2A

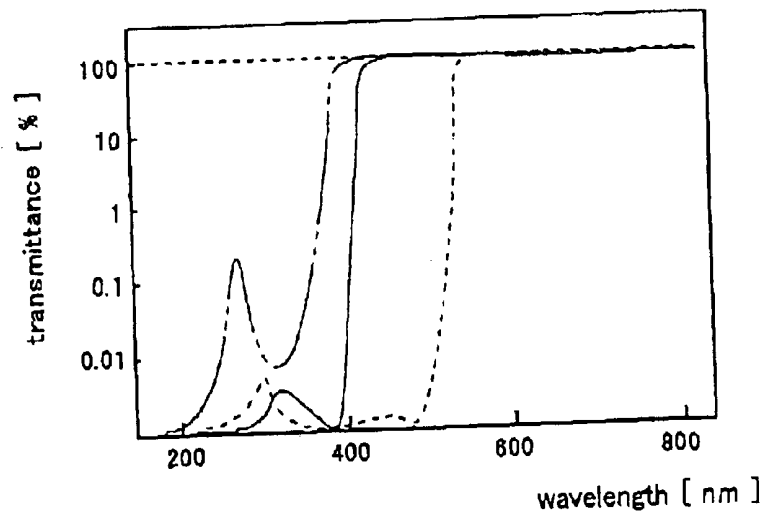


FIG. 2B

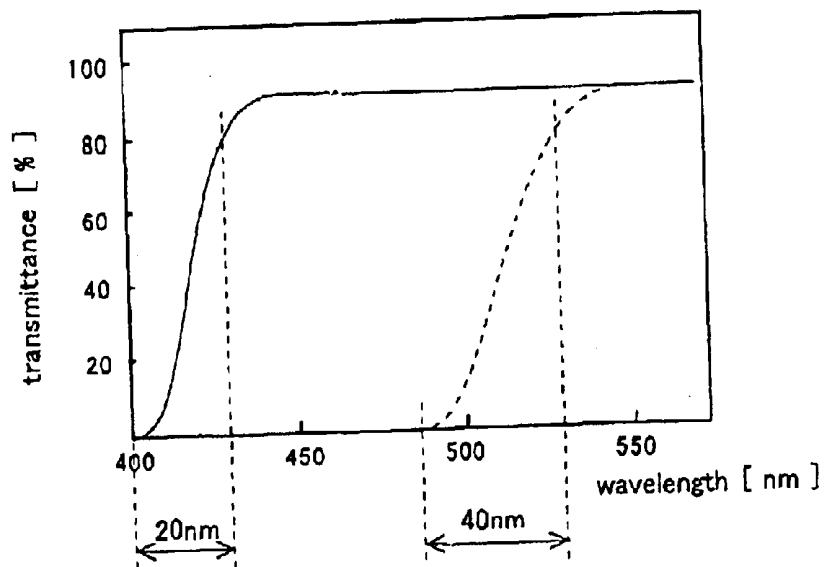


FIG. 3

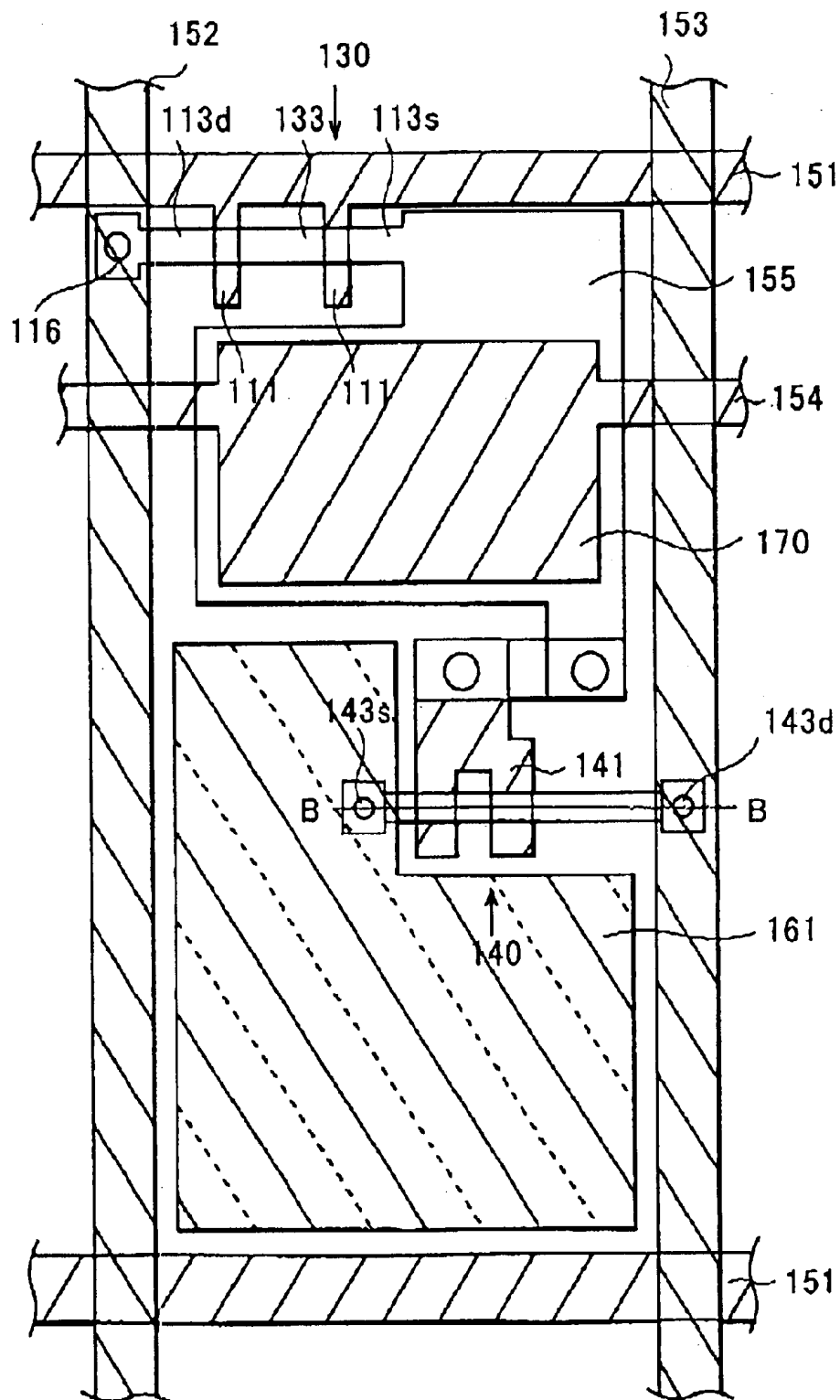


FIG. 4

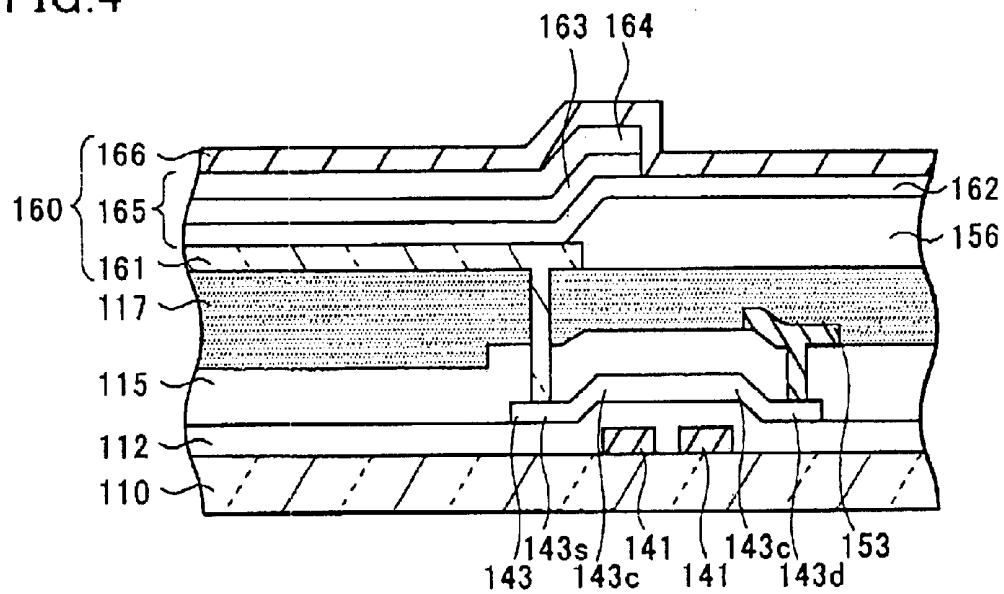


FIG. 5A

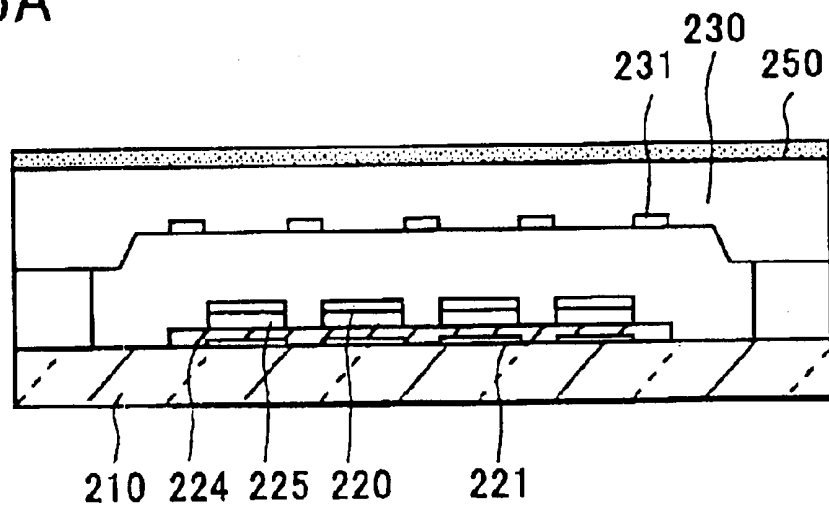


FIG. 5B

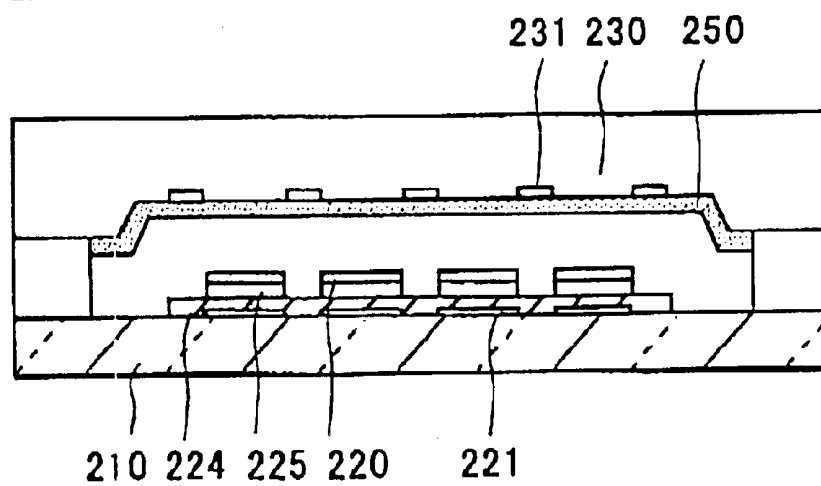
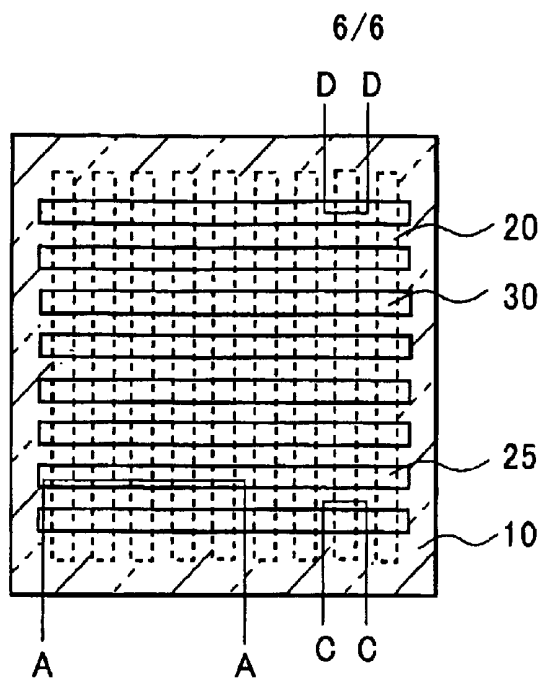
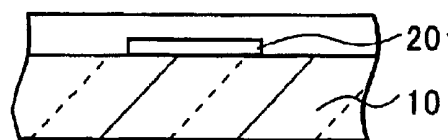


FIG. 6A



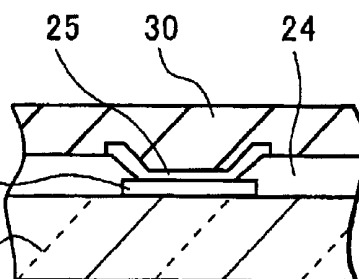
Prior Art

FIG. 6B



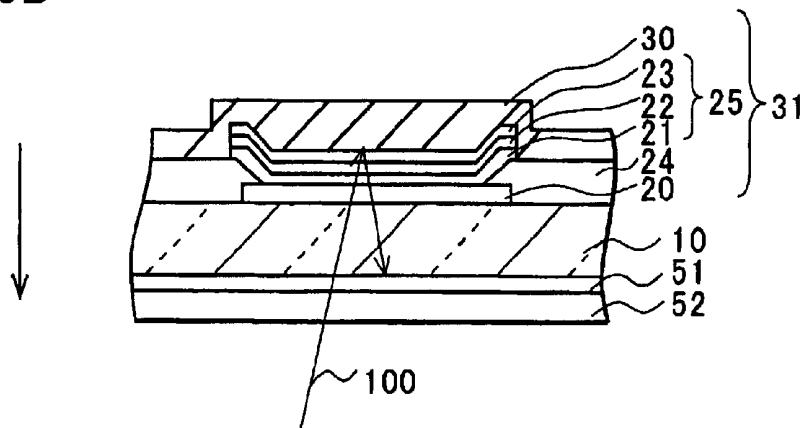
Prior Art

FIG. 6C



Prior Art

FIG. 6D



Prior Art

ELECTROLUMINESCENT DISPLAY DEVICE WITH ULTRAVIOLET PROTECTION FILM

BACKGROUND OF THE INVENTION

1. Field of the Invention

This invention relates to an electroluminescent (EL) display device, specifically to an EL display device that includes an ultraviolet protection film.

2. Description of the Related Art

FIG. 6A shows a plan view of a conventional passive-type EL display device, FIG. 6B shows a sectional view of the EL display device along line C—C of FIG. 6A, FIG. 6C shows a sectional view along line D—D of FIG. 6A, and FIG. 6D shows a partially expanded view of FIG. 6C with a conventional ultraviolet cut-off structure.

As shown in FIG. 6A, linear anodes **20**, which extend vertically in the figure and are formed from ITO (indium tin oxide) that is a transparent conductive material, and linear cathodes **30**, which extend horizontally in the figure, are placed on an insulating substrate **10**. At the intersections of the vertical anodes **20** and the horizontal cathodes **30**, organic EL layers **25** having light emitting layers formed from an organic material are provided between the anodes **20** and the cathodes **30**. This three-layer structure forms an organic EL element **31**.

As shown in FIG. 6D, the anode **20** formed of a transparent conductive film is provided on the insulating substrate **10**. The organic EL layer **25** formed on the anode **20** includes a hole transporting layer **21** having a first hole transporting layer made of MTDATA (4,4',4"-tris(3-methylphenylphenylamino)triphenylamine) and a second hole transporting layer made of TPD (N,N'-diphenyl-N,N'-di(3-methylphenyl)-1,1'-biphenyl-4,4'-diamine), a light emitting layer **22** made of Beq2 (10-benzo[h]quinolinol-beryllium complex) containing quinacridone derivative, and an electron transporting layer **23** made of Beq2. Furthermore, the cathode **30** made of aluminum (Al) is formed on the EL layer **25**. This cathode **30** is an opaque conductive film, and light emitted from the light emitting layer **22** passes through the insulating substrate **10** as the light for the display device. An insulating film **24** is placed between the anode **20** and the cathode **30**.

A sealing substrate (not shown) is attached to the insulating substrate **10** to cover the cathode of the insulating substrate **10**, and the organic EL element **31** as well as associated thin film transistors (TFT) are sealed between this sealing substrate and the insulating substrate **10**. This sealing substrate may be a metal or a glass. The organic EL layer **25** is not resistant to moisture, and therefore, it is desirable that the sealing is completed as quickly as possible.

External light **100** also enters the display device, and this light is reflected by the cathode **30** formed of an Al layer. This reflected light adds to the brightness of the display device. For example, in a black representation by the display device, a proper black representation cannot be obtained. Therefore, as shown in FIG. 6D, a retardation film **51** and a circular polarizer **52** are provided on the insulating substrate to cut the light reflected by the cathode **30** to achieve the proper black representation.

Since the transmission of the circular polarizer **52** is approximately 40% through 50%, only about a half of the light generated at the light emitting layer **22** is used as display light. Accordingly, this low light transmission of the circular polarizer **52** coupled with the retardation film **51**

reduces the amount of ultraviolet rays that reaches the organic EL layer **25**. The conventional display device relies on the circular polarizer **52** and the retardation film **51** to maintain a proper life time of the organic EL layer, which is subject to an accelerated light emission character degradation upon illumination by ultraviolet rays.

SUMMARY OF THE INVENTION

The invention provides an electroluminescent display device that includes an anode, a cathode and a light emitting layer disposed between the anode and the cathode. The display device also includes a substrate allowing light from the light emitting layer to pass through itself and an ultraviolet protection film disposed in an optical path of the light passing through the substrate.

The invention also provides an electroluminescent display device that includes a substrate having a thin film transistor thereon, and an ultraviolet protection film disposed over the thin film transistor and having an average transmission at visible region at least 80 times as high as an average transmission at ultraviolet region. The display device also includes an anode disposed over the ultraviolet protection film, a light emitting layer disposed over the anode and being driven by the thin film transistor, and a cathode disposed over the light emitting layer.

The invention further provides an electroluminescent display device that includes a first substrate having a thin film transistor thereon, an anode disposed over the first substrate, a light emitting layer disposed over the anode and being driven by the thin film transistor, and a cathode disposed over the light emitting layer. The display device also includes a second substrate disposed over the light emitting layer, and an ultraviolet protection film disposed on a surface of the second substrate and having an average transmission at visible region at least 80 times as high as an average transmission at ultraviolet region.

The invention also provides an electroluminescent display device that includes an anode, a cathode, a light emitting layer disposed between the anode and the cathode, a substrate which light from the light emitting layer passes through, and means for preventing an ultraviolet ray from reaching the light emitting layer.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1A is a cross-sectional view of an electroluminescent display device of a first embodiment of the invention, FIG. 1B is a partially expanded view of FIG. 1A, and FIG. 1C is a cross-sectional view the display device of FIG. 1A with a modification.

FIG. 2A shows transmissions of three ultraviolet protection films for the device of FIG. 1A as a function of wavelength, and FIG. 2B is a partially expanded view of FIG. 2A.

FIG. 3 is a plan view of a pixel element of an electroluminescent display device of a second embodiment of the invention.

FIG. 4 is a cross-sectional view of the display device of FIG. 3.

FIGS. 5A and 5B are sectional views of the display devices of FIG. 1A modified for a top emission structure.

FIG. 6A is a plan view of a conventional bottom emission electroluminescent display device, and FIGS. 6B–6D are cross-sectional views of the display device of FIG. 6A.

DETAILED DESCRIPTION OF THE INVENTION

A passive-type EL display device with a bottom emission structure is described as a first embodiment of the invention.

The plan view of this display device is the same as that of FIG. 6A. FIG. 1A is a cross-sectional view of this display device cut along line A—A of FIG. 6A. FIG. 1B is a partially expanded view of FIG. 1A showing the detailed structure of the display device. The components of this embodiment that are the same as the components of the display device of FIG. 6A are indicated by the same reference numerals.

An ultraviolet protection film **50** formed by applying an acrylic transparent resin is provided on the entire surface of an insulating substrate **10**. This film has a thickness of approximately 1.2 μm , and has a transmission characteristics, which allow higher transmission of visible rays than ultraviolet rays. As shown in FIG. 6A, linear anodes **20** made of ITO extend vertically in the figure, and linear cathodes **30** extend horizontally in the figure. An organic EL element **31**, which includes the anode **20**, the cathode **30** and organic EL layers **25** having light emitting layers made of an organic material placed between the two electrodes **20**, **30**, is provided at the intersections of the anodes **20** extending vertically and the cathodes **30** extending horizontally.

As shown in FIG. 1B, the anode **20** is provided on the insulating substrate **10**. The organic EL layer **25** formed on the anode **20** includes a hole transporting layer **21** having a first hole transporting layer made of MTDATA (4,4',4"-tris (3-methylphenylphenylamino)triphenylamine) and a second hole transporting layer made of TPD (N,N'-diphenyl-N,N'-di(3-methylphenyl)-1,1'-biphenyl-4,4'-diamine), a light emitting layer **22** made of Beq2 (10-benzo[h]quinolinol-beryllium complex) containing quinacridone derivative, and an electron transporting layer **23** made of Beq2. Furthermore, the cathode **30** made of Al is formed on the EL layer **25**. This cathode **30** is an opaque conductive film, and light emitted from the light emitting layer **22** passes through the insulating substrate **10** as the light for the display device. This structure is a typical bottom emission structure, which allows viewing of light through the substrate **10**.

As is the case with the display device of FIG. 6A, a sealing substrate (not shown) is attached to the insulating substrate **10** to cover the cathode of the insulating substrate **10**, and the organic EL element **31** as well as associated TFTs are sealed between this sealing substrate and the insulating substrate **10**. This sealing substrate may be a metal or a glass. An antireflection film (not shown) made of molybdenum is placed between the anode **20** and the insulating substrate **10** to reduce the reflection of incoming external light. This antireflection film may be placed on any surface that reflects the incident light. Accordingly, this embodiment does not require the polarizer or the retardation film of the display device of FIG. 6A.

The ultraviolet protection film **50** of this embodiment has a transmission of 80% or higher as an average over the visible region and a transmission of 1% or lower as an average over the ultraviolet region. In this embodiment, a film that has a visible-range transmission at least 80 times as high as the ultraviolet-range transmission is effectively used as the ultraviolet protection film.

By providing this ultraviolet protection film **50**, the organic EL element **31** can be protected from ultraviolet rays without using a circular polarizer or the retardation film. As described above, the retardation film and the polarizer allow transmission of only about 40–50%, though the polarizer contributes to the low transmission much more than the retardation film does. This low transmission does not depend much on the wavelength, and almost constant throughout the entire wavelength region, i.e., ultraviolet to visible. On the

other hand, the ultraviolet protection film **50** of this embodiment has a much higher transmission, i.e., 80% or higher, at the visible region than at the ultraviolet region. Accordingly, since visible rays are effectively transmitted through the ultraviolet protection film **50**, the configuration of this embodiment utilizes light from the light emitting layer **22** much more effectively as display light than the configuration of the conventional display device.

The ultraviolet protection film **50** may be attached to the observer side of the insulating substrate **10** as shown in FIG. 1C. Namely, the ultraviolet protection film **50** is provided on the external surface of the insulating substrate **10**. Because of the ultraviolet protection film **50**, the display device of this embodiment does not need the retardation film or the polarizer to protect the organic EL layer **25** from ultraviolet rays. Light from the light emitting layer **22** passes through the insulating substrate **10** and is viewed by an observer. As is the case with the display device of FIG. 1A, the organic EL layers **25**, the two electrodes **20**, **30** and the TFTs are placed on the inner side of the substrate **10**.

Furthermore, the ultraviolet protection film **50** may be placed anywhere in the optical path from the light emitting layer **22** to the observer, and does not have to be placed on the insulating substrate **10**. For example, when the EL display device is used as a display component of a mobile telephone or mobile computing device, the ultraviolet protection film **50** may be placed outside the EL display device itself to cover the device when it is exposed to external light during its use.

In this embodiment, the light emitting layer **22**, the anode **20** and the insulating substrate **10** form an optical path for radiating light that is generated in the light emitting layer **22**. External light enters through the same optical path in the opposite direction.

Ultraviolet rays contained in this external light accelerates the deterioration of the EL layer **25**, especially the light emitting layer **22**. The ultraviolet protection film **50** may be provided on any of the layers provided in this optical path, though the location of the ultraviolet protection film **50** shown in FIG. 1A is most effective in this embodiment.

FIGS. 3 and 4 show an active-type EL display device with a bottom emission structure of a second embodiment of this embodiment.

FIGS. 2A and 2B show the transmission characteristics of ultraviolet protection film **50** of this embodiment. Three acrylic resins were formed as the ultraviolet protection film **50** and the transmission characteristics of the three films were measured. The transmission of the film made of a first resin is indicated by the solid line, that of the film made of a second resin is indicated by the evenly broken line, and that of the film made of a third resin is indicated by the unevenly broken line in FIG. 2A, which has the Y-axis in the logarithmic scale. Only those of the first resin and the second resin are shown in FIG. 2B, which is a partially expanded view along the X-axis of FIG. 2A. All of the three resins show, when they are formed as a ultraviolet protection film, a low transmission at the ultraviolet region, and thus generally qualify as the ultraviolet protection film **50**.

However, closer examination of the transmission characteristics reveals preferences of the resins to be used as the ultraviolet protection film of this invention. First, the film made of the second resin has a transmission of only about 50% even at around 520 nm. The wavelength region around 500 nm is a transition region from blue to violet, and is still visible to human eyes. If the ultraviolet protection film **50** made of the second resin is used in a full color display

device, the light emission in the wavelength region must be enhanced in comparison to the light emissions of other wavelength regions to keep a proper color balance. This leads to an excessive use of the light emitting layer for this wavelength region, and an early degradation of this light emitting layer and the display device itself. Accordingly, it is better for the ultraviolet protection film **50** to have not only a low ultraviolet transmission but also a high transmission throughout the visible range. Preferably, the ultraviolet protection film **50** has a transmission equal to or higher than 80% above 430 nm. The device characteristics are further improved if the transmission is equal to or higher than 85% above 430 nm, and equal to or higher than 90% above 440 nm.

Second, the film made of the third resin has a high transmission throughout the visible light region. The transmittance is close to 100% even below 400 nm. Accordingly, this film is good in terms of a full color display application. However, the transmission shows a local maximum of about 0.1% at around 250 nm. Although the transmission of 0.1% may be appropriate for some other ultraviolet protection, it was found that even the transmission at this level eventually contributes to the acceleration of the degradation of the light emitting layer of the organic EL display device. It is better for the transmission not to exceed 0.05% at a wavelength below 350 nm. Preferably, the transmission of the ultraviolet protection film **50** of this invention does not exceed 0.01% at a wavelength below 350 nm.

The film made of the first resin is most suitable, among the three films shown in FIG. 2A, for the ultraviolet protection film **50** of this embodiment. The transmission of this film is equal to or higher than 90% above 440 nm and equal to or higher than 85% above 430 nm, and does not exceed 0.01% at any wavelength below 350 nm.

In addition to these transmission characteristics, the film made of the first resin shows a steep change in the transmission, as shown in FIG. 2B. The transmission remains at its maximum transmission, i.e., approximately 90%, down to about 435 nm, and reduces to about 80% at 425 nm. The transmission further reduces to about 1% at about 405 nm. The transmission changes from 80% to 1% while the wavelength changes by 20 nm. On the other hand, the film made of the second resin shows more gradual change in the transmission. The transmission of this film is 80% at about 515 nm and 1% at about 475 nm. The transmission changes from 80% to 1% while the wavelength changes by 40 nm. It would be the best to have a ultraviolet protection film that has a step-like transition from the ultraviolet region to the visible region and thus provides no reduction of the transmission at the visible violet region. However, such a ultraviolet protection film simply does not exist. Accordingly, the practical approach is to choose a ultraviolet protection film that has an ultraviolet-visible transition as steep as possible. The less is the reduction of the transmission at the visible violet region, i.e., a steeper transition, the less complicated is the device design to compensate for this reduction of the transmission.

Preferably, the change in the transmission from 1% to the maximum transmission subtracted by 10% occurs while the wavelength changes by 40 nm or less. More preferably, the same change in the transmission occurs while the wavelength change by 20 nm or less.

FIG. 3 shows a plan view showing one display pixel of the organic EL display device, and FIG. 4 shows a sectional view along line B—B of FIG. 3.

As shown in FIG. 3, a display pixel is formed in the region surrounded by a plurality of gate signal lines **151** extending

in a row direction and a plurality of drain signal lines **152** extending in a column direction. A switching TFT **130** is provided in the vicinity of the intersection between these signal lines, and the source **113s** of the TFT **130** serves simultaneously as a capacitor electrode **155** that has a capacitance between itself and a retaining capacitor electrode **154**, and is connected to the gate **141** of a second TFT **140** that drives the organic EL element **160**. The source **143s** of the second TFT **140** is connected to the anode **161** of the organic EL element **160**, and the drain **143d** at the other side is connected to a drive power supply line **153** that drives the organic EL element **160**.

In the vicinity of the TFT, the retaining capacitor electrode **154** is disposed parallel to the gate signal line **151**. This retaining capacitor electrode **154** is made of chromium, and has a capacitance between itself and the capacitor electrode **155** that is connected to the source **113s** of the switching TFT **130** via a gate insulating film **112**. This retaining capacitor **170** is provided for retaining a voltage to be applied to the gate **141** of the second TFT **140**.

The cathode **166** of the organic EL element **160** is provided over the entire substrate **110** of the organic EL display device.

In the second TET **140**, a gate electrode **141** made of a high melting point metal, such as Cr and Mo, or its alloy is provided on the insulating substrate **110** made of a non-alkali glass, and a gate insulating film **112** and an active layer **143** formed of a poly-silicon film are formed in this order. The active layer **143** is provided with a channel **143c** that is intrinsic or substantially intrinsic above the gate electrode **141**, and a source **143s** and a drain **143d** at both sides of this channel **143c**, which are formed by ion doping.

An interlayer dielectric layer **115** including an SiO₂ film, an SiN film, and an SiO₂ film that are laminated in this order is formed on the entire upper surfaces of the gate insulating film **112** and the active layer **143**. A contact hole made in accordance with the drain **143d** is filled with a metal such as Al, to form a drive power supply line **153** connected to a drive power supply.

An ultraviolet protection film **117** made of, for example, an acrylic transparent resin is further formed on the entire surface. This ultraviolet protection film **117** has the transmission characters as the ultraviolet protection film **50** of the first embodiment.

A contact hole is formed in the ultraviolet protection film **117** and the interlayer dielectric layer **115** at a position corresponding to the source **143s**, and a transparent electrode made of ITO, that is, an anode **161** of an organic EL element **160**, which is in contact with the source **143s** through this contact hole, is provided on the ultraviolet protection film **117**. An antireflection film (not shown) made of molybdenum is placed between the anode **161** and the ultraviolet, protection film **117**.

The organic EL element **160** includes the same components as the first embodiment. An organic EL layer **165** is formed on the anode **161**. The organic EL layer **165** includes a hole transport layer **162**, a light emitting layer **163** and an electron transport layer **164**. A cathode **166** is formed on the electron transport layer **164**. The step at the edge of the anode **161** may break the organic EL layer **165** if the organic EL layer **165** is formed over the step. To prevent this breaking of the organic EL layer **165** at the step, a second flattening film **156** is disposed under the electron transporting layer **162**.

A sealing substrate (not shown) is attached to the cathode side of the substrate **110**, and the TFT and the EL element are

sealed between this sealing substrate and the insulating substrate **110**. This sealing substrate can be formed from either a metal or a glass. In this embodiment, the retardation film or the polarizer of the conventional display device is not required to protect the organic EL layer **165** from ultraviolet rays.

In the organic EL element **160**, holes injected from the anode and electrons injected from the cathode are re-combined inside the light emitting layer **163** and excite organic molecules that form the light emitting layer **163** to generate excitons. In the process of relaxation of the excitons, light is emitted from the light emitting layer **163**, and this light is emitted to the outside through the transparent insulating substrate **110** and the transparent anode.

In this embodiment, the light emitting layer **163**, the anode **161** and the transparent insulating substrate **110** form an optical path for radiation of light emitted from the light emitting layer **163**, and external light enters the display device along the same optical path in the opposite direction.

This embodiment is characterized in that an ultraviolet protection film **117** is formed in this optical path. When the film made of the first resin shown in FIGS. **2A** and **2B** is used as the ultraviolet protection film in this embodiment, the transmission of the ultraviolet rays is less than 0.01%. Thus, even when the circular polarizer or the retardation film of the conventional display device is not provided, deterioration of the organic EL element **160** due to ultraviolet rays can be prevented. Particularly, as in this embodiment, it is preferred that the ultraviolet protection film **117** is formed from an acrylic resin between the anode **161** and the TFTs. The reason for use of an acrylic resin is that the acrylic resin cuts off ultraviolet rays, and at the same time is able to make the surface of the device intermediate flat enough for the subsequent processing steps. Accordingly, the ultraviolet protection film **117** also serves as a flattening film. When the first resin shown in FIGS. **2A** and **2B** is used, the ultraviolet protection film, which is also the flattening film, is applied on the substrate by spin coating.

The ultraviolet protection film **117** may be provided on any of the layers as long as the ultraviolet protection film **117** is placed closer to an observer than the EL layer **165**.

Furthermore, the ultraviolet protection film of the first and second embodiments may be applied to an EL display device with a top emission structure. The description given below employs a passive-type EL display device as an example. However, the ultraviolet protection film may also be applied to an active matrix type EL display device with a top emission structure.

The difference between the top emission structure and the bottom emission structure is that light is viewed through a sealing substrate **230** in the top emission structure, and that light is viewed through an insulating substrate **110** in the bottom emission structure. The configuration of the top emission structure is the same as the bottom emission structure shown in FIG. **4** except that the cathode is formed by laminating an extremely thin metal film and a transparent electrode made of ITO or IZO (indium zinc oxide). Furthermore, as shown in FIGS. **5A** and **5B**, the lamination order of the layers in the organic EL element **160** may be reversed. In such a configuration, a common cathode **224** is placed at the bottom of the organic EL element **160**, and an anode **161** made of ITO is placed at the top of the organic EL element **160**. Namely, the lowest layer is the cathode **224**. An organic EL layer **225** including an electron transporting layer, a light emitting layer **164** and a hole transporting layer is placed on the cathode **224**. The anode **220** including an

ITO film and a film of Ag/Mg alloy is provided on the organic EL layer.

An antireflection film (not shown) is placed on the anode **220**. Light emitted from the light emitting layer **164** of the organic EL element **225** passes through a transparent sealing substrate **230**, and reaches an observer of the display device. An ultraviolet protection film **250** is placed in the optical path of the light emitted from the light emitting layer **164** and passing through the sealing substrate **230**. In the bottom emission structure shown in FIG. **4**, the ultraviolet protection film is spin-coated on the substrate before the formation of the organic EL element. However, in the top emission structure, the spin coating is not appropriate since the coating solution may penetrate into the organic EL elements that are already formed on the substrate prior to the formation of the ultraviolet protection film. In this embodiment, the ultraviolet protection film **250** is formed on the external surface of the sealing substrate **230** as shown in FIG. **5A**, or on the internal surface of the sealing substrate **230** as shown in FIG. **5B**. The sealing substrate **230** is attached to the anode side of the insulating substrate **210**, and the TFTs and the EL element are sealed between the sealing substrate **230** and the insulating substrate **210**.

In the organic EL element **160**, holes injected from the anode **220** and electrons injected from the cathode **224** are re-combined inside the light emitting layer and excite organic molecules forming the light emitting layer to generate excitons. In the process of relaxation of the excitons, light is emitted from the light emitting layer. This light passes through the sealing substrate **230** and the transparent anode **220**, to escape from the sealing substrate side of the display device.

In this embodiment, the light emitting layer, the anode **220** and the sealing substrate **230** form an optical path.

In the top emission structure, an observer views light through the sealing substrate **230**, so that the sealing substrate **230** may be formed of a transparent substrate such as a glass or an acrylic substrate. However, since this sealing substrate is used for preventing the entry of moisture, a glass substrate is preferable. Furthermore, on the sealing substrate **230**, in order to prevent the wiring between the pixels from being viewed, a black matrix **231** is provided. Furthermore, on the insulating substrate **210**, a reflector **221** for preventing light penetration is provided. An ultraviolet protection film **250** is provided by an application of an acrylic resin.

The top emission structure has fewer restrictions in design of the numerical aperture than in the bottom emission structure, so that the numerical aperture can be larger than that of the bottom emission structure having the same pixel area.

The ultraviolet protection film **250** may be also provided on the EL element side of the display device, as shown in FIG. **5B**. Either way, the ultraviolet protection film **250** may be provided on any of the layer as long as the ultraviolet protection film is placed closer to an observer than the organic EL layer **225**.

The display devices of these embodiments achieve a display use period equal to or longer than that of the conventional display device of FIG. **6D**, which includes the polarizer and the retardation film. Furthermore, because the display devices of these embodiments do not need the polarizer and the retardation film of the conventional display device required for reducing the amount of ultraviolet rays entering the EL elements, much simpler structures designed only for preventing the internal light reflection may be provided together with the ultraviolet protection layer.

Therefore, the structure of the display device may become significantly less complicated.

What is claimed is:

1. An electroluminescent display device comprising:
an anode;
a cathode;
a light emitting layer disposed between the anode and the cathode;
a substrate which light from the light emitting layer passes through; and
an ultraviolet protection film disposed in an optical path of the light passing through the substrate, the ultraviolet protection film having a substantially lower transmission at 400 nm than at 600 nm.
2. The electroluminescent display device of claim 1, wherein the ultraviolet protection film has a transmission of 80% or higher as an average over visible region and a transmission of 1% or lower as an average over ultraviolet region.
3. The electroluminescent display device of claim 1, wherein the ultraviolet protection film has an average transmission in the visible region at least 80 times as high as an average transmission in the ultraviolet region.
4. The electroluminescent display device of claim 1, wherein the ultraviolet protection film is disposed between the substrate and the light emitting layer.
5. The electroluminescent display device of claim 1, wherein the ultraviolet protection film is in contact with the substrate.
6. The electroluminescent display device of claim 1, 2, 3 or 4, wherein
the anode is disposed over the substrate, the light emitting layer is disposed over the anode, and the cathode is disposed over the light emitting layer, and
the ultraviolet protection film comprises a flattening film covering a thin film transistor that drives the light emitting layer.
7. The electroluminescent display device of claim 1, 2, 3 or 4, further comprising an insulating substrate, wherein the anode is disposed over the insulating substrate, the light emitting layer is disposed over the anode, the cathode is disposed over the light emitting layer, and the ultraviolet protection film is disposed on the substrate which light from the light emitting layer passes through.
8. The electroluminescent display device of claim 1, 2, 3 or 4, wherein the ultraviolet protection film is made of an acrylic resin.
9. The electroluminescent display device of claim 1, 2, 3 or 4, wherein a transmission of the ultraviolet protection film of any wavelength below 400 nm does not exceed 1%.
10. The electroluminescent display device of claim 1, 2, 3 or 4, wherein a transmission of the ultraviolet protection film of any wavelength below 400 nm does not exceed 0.01%.

11. The electroluminescent display device of claim 1, 2, 3 or 4, wherein a transmission of the ultraviolet protection film of any wavelength above 430 nm does not fall below 80%.

12. The electroluminescent display device of claim 1, 2, 3 or 4, wherein a transmission of the ultraviolet protection film of any wavelength above 440 nm does not fall below 90%.

13. The electroluminescent display device of claim 1, 2, 3 or 4, wherein a transmission of the ultraviolet protection film changes from 1% to the maximum transmission subtracted by 10% for an increment of wavelength of 40 nm or less.

14. The electroluminescent display device of claim 8, wherein the ultraviolet protection layer has a thickness of approximately 1.2 μm .

15. The electroluminescent display device of claim 1, wherein the ultraviolet protection film does not have a transmission of 1% or higher at a wavelength of 400 nm or shorter.

16. An electroluminescent display device comprising:
a substrate having a thin film transistor thereon;
an ultraviolet protection film disposed over the thin film transistor and having an average transmission at visible region at least 80 times as high as an average transmission at ultraviolet region;
an anode disposed over the ultraviolet protection film;
a light emitting layer disposed over the anode and being driven by the thin film transistor; and
a cathode disposed over the light emitting layer.

17. An electroluminescent display device comprising:
a first substrate having a thin film transistor thereon;
an anode disposed over the first substrate;
a light emitting layer disposed over the anode and being driven by the thin film transistor;
a cathode disposed over the light emitting layer;
a second substrate disposed over the light emitting layer; and
an ultraviolet protection film disposed on a surface of the second substrate and having an average transmission in the visible region at least 80 times as high as an average transmission in the ultraviolet region.

18. An electroluminescent display device comprising:
an anode;
a cathode;
a light emitting layer disposed between the anode and the cathode;
a substrate which light from the light emitting layer passes through; and
means for preventing an ultraviolet ray from reaching the light emitting layer.

* * * * *

专利名称(译)	具有紫外线保护膜的电致发光显示装置		
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[标]申请(专利权)人(译)	三洋电机株式会社		
申请(专利权)人(译)	SANYO ELECTRIC CO. , LTD.		
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摘要(译)

一种电致发光显示装置，包括阳极，阴极和设置在阳极和阴极之间的发光层。显示装置还包括允许来自发光层的光穿过其自身的基板和设置在穿过基板的光的光路中的紫外线保护膜。在减少紫外线对显示特性劣化的影响方面，用紫外线保护膜代替常规电致发光显示装置中使用的延迟膜和偏振器。

